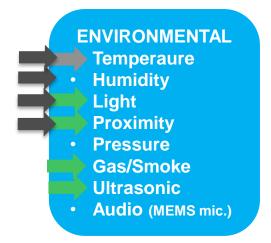
SENSOR highlights

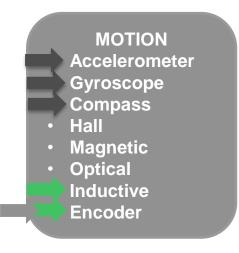
E.Marinoni – v 1.0 January 2018

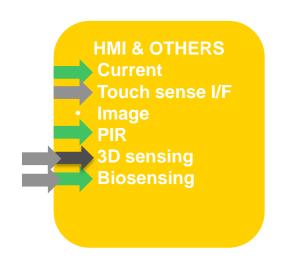
IVNET SILICA



SENSOR categories overview







- Not only pure sensor elements
- Combined functions
- Sometimes integrated in the MCU

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ultra low-power high performance 3-axis femto

Ultra low power, high-performance and small package combined into a single product

- Wide supply voltage: 1.62 to 3.6V
- Independent IO supply
- Ultra low power consumption:
- 50nA in low power mode
- below 1uA in active low-power mode
- Very low noise: down to 1.3 mg RMS in low-power mode
- Multiple operating modes with multiple bandwidths
- $\pm 2g/\pm 4g/\pm 8g/\pm 16g$ full scale
- Single data conversion on demand
- 32 level FIFO
- Embedded temperature sensor
- 10000g shock survivability
- Ultra small: 2.0 x 2.0 x 0.7mm LGA package



Parameter		High- Performance Mode	Low-Power Mode 4	Low-Power Mode 3	Low-Power Mode 2	Low-Power Mode 1
Resolution [bit]	Resolution [bit]		14-bit	14-bit	14-bit	12-bit
ODR [Hz]		12.5 - 1600	1.6 - 200	1.6 - 200	1.6 - 200	1.6 - 200
BW [Hz]		ODR/2 (N/A for 1600 Hz), ODR/4, ODR/10, ODR/20	180 ODR/4, ODR/10, ODR/20	360 ODR/4, ODR/10, ODR/20	720 ODR/4, ODR/10, ODR/20	3200 ODR/4, ODR/10, ODR/20
Noise density [μg/√Hz] @ FS = ±2 g, ODR=200 Hz		110	160	210	300	550
	ODR=1.6 Hz	-	0.65	0.55	0.45	0.38
	ODR=12.5 Hz	90	4	2.5	1.6	1
Current consumption [µA] @ Vdd=1.8 V	ODR=25 Hz	90	8.5	4.5	3	1.5
	ODR=50 Hz	90	16	9	5.5	3
	ODR=100 Hz	90	32	17.5	10.5	5
	ODR=200 Hz	90	63	34.5	20.5	10
	ODR=400, 800, 1600 Hz	90	-	-	-	-

1.5µA @ 25Hz

try this vs. ADI ADXL362



ST accelerometer comparison

	LIS2DW12	LIS2DS12	LIS2HH12	LIS2DH12	LIS2DE12
Package (mm)	2x2x 0.7 – LGA-12	2x2x.86 – LGA-12	2x2x1 – LGA-12	2x2x1 – LGA-12	2x2x1 – LGA-12
Full scales (g)	±2/±4/±8/±16	±2/±4/±8/±16	±2/±4/±8	±2/±4/±8/±16	±2/±4/±8/±16
Resolution	5 modes: Low power (12 bit), 4x High res (14 bit)	3 modes: Low power (10 bit), Normal (12 bit), High res (14 bit)	3 modes: Low power (8 bit), Normal (10 bit), High res (16 bit)	3 modes: Low power (8 bit), Normal (10 bit), High res (12 bit)	1 mode: Low power (8 bit)
Sensitivity (mg)	0.244	0.244	0.061	1	15.6
Noise Density (±2g, 100Hz)	90µg/sqrt(Hz)	120µg/sqrt(Hz)	140µg/sqrt(Hz)	750µg/sqrt(Hz)	1315µg/sqrt(Hz)
Power cons. in PD Low Power Mode Normal Mode (μA)	0.05 0.38 @1.6Hz, 3 / 16 @50Hz 120 in HPM @50Hz	0.7 2.5 @1Hz, 8 @50Hz, 150 from 12.5 up to 6.4kHz	5μΑ / - /110μΑ @ 50Hz 180μΑ up to 800Hz	0.5 2 @1Hz, 6 @ 50Hz 11 @50Hz	0.5 2 @1Hz, 6 @50Hz no normal mode
0g level offset accuracy (Typ)	±20 mg	±30 mg	±30 mg	±40 mg	±100 mg
0g level change vs. Temp	±0.2 mg/°C	±0.3 mg/°C	±0.25 mg/°C	±0.5 mg/°C	±0.5 mg/°C
ODR	One shot, 1.6Hz- 1.6KHz	1 Hz – 6.4kHz	10Hz-800Hz (HR)	1Hz-5.376 kHz (Low power), 1Hz-1.344 kHz (Normal, HR)	1Hz-5.376 kHz (Low power)
BW	Up to ODR/2	Up to ODR/2	Up to ODR/2	ODR/2 (LPM and NM), ODR/9 (HR)	ODR/2 (Low power)
FIFO	32-level	256 level FIFO (14b), 768 level (if XL module)	32-level	32-level (10bit)	32-level (10bit)
Self-test / Temp sensor	Yes / Yes (1 digit/°C)	Yes / Yes	Yes / 11bit resolution (8 digit/°C)	Yes / Yes	Yes / Yes
Power supply	1.62 to 3.6 V	1.62 to 1.98 V	1.71 to 3.6 V	1.71 to 3.6 V	1.71 to 3.6 V

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VERY LOW POWER 6AXIS COMBO

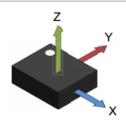
LSM6DSL

iNEMO inertial module: 3D accelerometer and 3D gyrocope

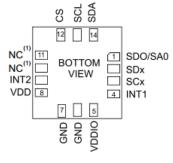
Features

- Sel. $\pm 2/\pm 4/\pm 8/\pm 16$ g accel. full scale
- Sel. ±125/±245/±500/±1000/±2000 dps gyro full scale
- Power consumption:
 - 400 μA in combo normal mode
 - 650 μA in combo high-performance mode
- SPI & I2 C serial interface with main processor data synchronization feature
- Smart FIFO up to 4 kbyte based on features set
- Android M compliant
- Hard, soft ironing for external magnetic sensor corrections
- Compact footprint, 2.5 mm x 3 mm x 0.83 mm
- Pedometer, step detector and step counter
- Significant motion and tilt function
- Standard interrupts: free-fall, wakeup, 6D/4D orientation, click and double-click
- Embedded temperature sensor









Vibration monitoring application up to 3.3Khz (6.6Khz ODR)



INDUSTRIAL GRADE 6 AXIS COMBO

ISM330DLC

iNEMO inertial module: 3D accelerometer and 3D gyrocope

Inertial module tailored for industry 4.0 applications

Features

- Sel. ±2/±4/±8/±16 g accel. full scale
- Sel. ±125/±245/±500/±1000/±2000 dps gyro full scale
- 16 bit resolution
- 90 μg/√Hz typ. accelerometer noise density
- SPI & I2 C serial interface with main processor data synchronization feature
- Smart FIFO up to 4 kbyte based on features set
- Sensor hub feature to efficiently collect data from additional
- external sensors
- Embedded hard, soft ironing for external magnetic sensor corrections
- Embedded temperature sensor
- Embedded self-test both for gyroscope and accelerometer
- High shock survivability
- Extended operating temperature range (-40°C to +85°C)







ISM330DLC









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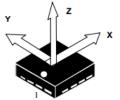
behaviour

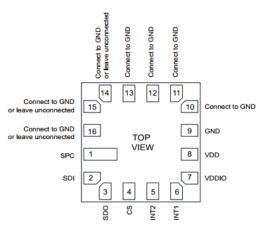
3-axis accelerometer specific for high precision INCLINOMETER

Features

- 16bit accelerometer
- Supply voltage 1.7 to 3.6V
- Full -Scale +/-2.5g
- Zero-g noise density: 45µg/√Hz (Max)
- High StabilityZero-g level change vs. temperature <0.4mg/°C
- Sensitivity change vs. temperature < 2%
- Embedded FIFO 32 Levels
- SPI 4-Wire digital output Interface
- Embedded temperature sensor (12-bit data output)
- CeramiccavityLGA16 5x5x1.7mm







LIS3DHH





P/N STEVAL-MKI180V1





High Accuracy Barometric Sensor

Optimizing the main blocks, we enhanced the performances: better noise, improved accuracy and reduced current consumption

World's smallest pressure sensor





Features

- 260 to 1260 mbar absolute pressure
- Pressure noise: down to 20µbar & 7.5µbar (LPF)
- ODR from 1 to **75Hz**, one shot
- Low power consumption: **12μA**(low noise) to **3μA**(low power)

 @1Hz
- 32 samples Embedded FIFO for **Pressure and Temperature**
- SPI and I²C interfaces.
- Smallest and thinnest form factor: 2x2x0.76 mm package

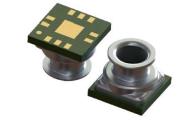
<20 cm accuracy
6cm with OPC</pre>

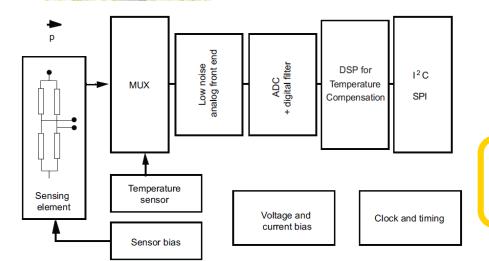
AVAILABLE Q2/Q3 2017

LPS33HW

Water Proof Barometric Sensor







Features

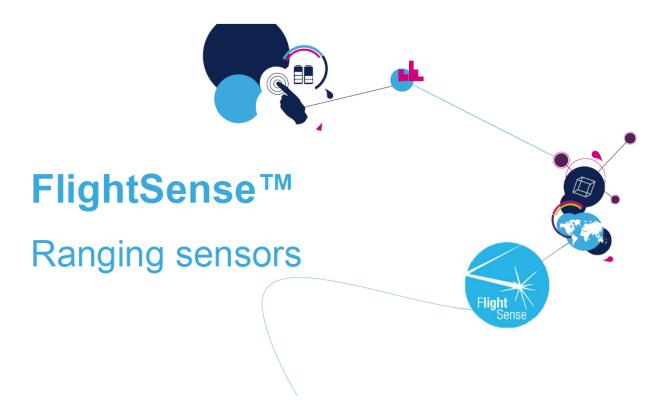
- 260 to 1260 mbar absolute pressure
- Less than 1Pa RMS of noise
- ODR from 1 Hz to 75 Hz
- Low power consumption: 4 µA
- SPI and I²C interfaces
- High shock survivability: > 20,000g
- **Embedded FIFO**

ISO 22810 Horology Certified

(Water Resistant Watches Standard)

IEC60529 (IP Code): IPx7 and IPx8 certified





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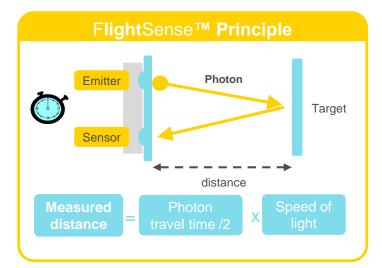




FlightSense™ ToF principle explanation

Measurement at the speed of light! 1cm round-trip at 67ps

3.3ps / mm !!



Fully Integrated Time of Flight Module
ST #1 World Wide Supplier

True distance measurement
Independent of target size, color & reflectance

Very fast (few ms)

Low power



12/2017

△VNET silica



ToF distance measurement system



FlightSense™ by ST is the only technology on the market today offering accurate measurements with tiny and low power modules

1	Flight Sense

	Conventional IR technologies	ST FlightSense [™]
Signal Amplitude	Yes	Yes
Real distance output	No (computed)	Real distance in mm (readable thru i ² C register)
Maximum distance	20cm	up to 2 meters (1)
Works with all objects color and reflectance	No	Yes even black (3%), gloves,
Gesture control Tap vs Swipe	No	Yes

12/2017

⚠VNET'SILICA





ST Flightsense™

VL6180X



- Proximity, Gesture & ALS sensor
- Up to 40cm Ranging

Proximity & Ambient Light Sensing Small 3-in-1 module, 4.8 x 2.8 x 1.0

850nm IR emission (Vcsel)

Advanced microcontroller and light rejection

Gesture control capability

Proximity detection and ranging, Smart lighting



VL53L0X

- Ranging sensor
- Up to 2m ranging
- Smallest ToF sensor in the market
 - Miniature 4.4 x 2.4 x 1.0 mm
- 940nm IR emission (Vcsel)
- Advanced microcontroller and light rejection
- User detection, long ranging

FUTURE PRODUCT (Q1 2018)



VL53L1X

Multi object ToF sensor

13

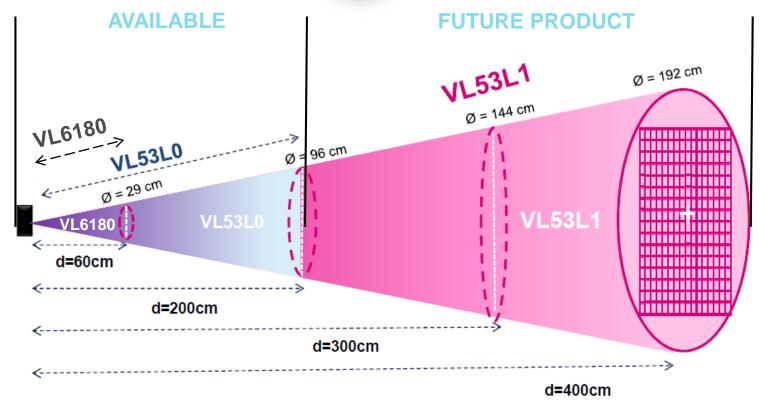
- Up to 4m ranging
- Full FoV ranging : 400cm+ (white target, no IR)
- Multi-object detection and Xtalk free
- Multi-zone scanning capable (100+ combinations for array selection)
- Enhanced speed (60Hz / ranging)

12/2017 **AVNET** silica





ST Flightsense™





FlightSense™ VL6180X Nucleo pack



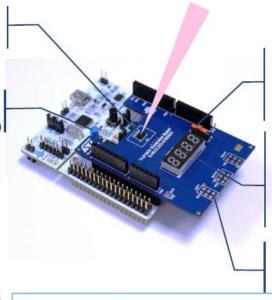
Push button

Mode selection (Scaler, interrupt etc...)

Graphical User Interface







Order code (available May 2015): P-NUCLEO-6180X1 (with stm32F401) P-NUCLEO-6180X2 (with stm32L053) X-NUCLEO-6180XA1 (expansion board)

Selection switch:

- Ranging mode
- Ambient Light mode

4-digit display

- Distance (mm)
- Ambient light (Lux)
- Gesture

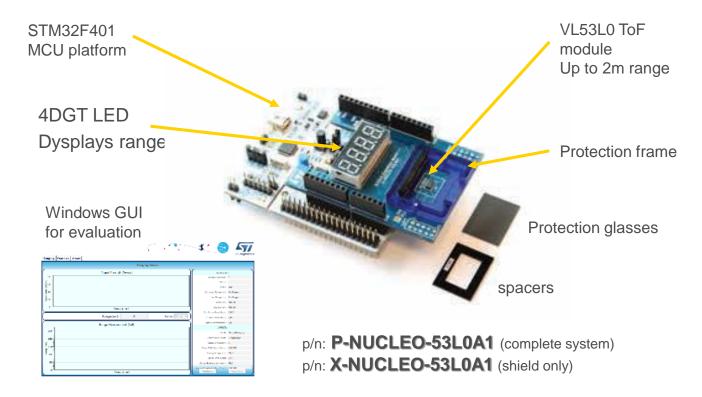
External sensor connection using VL6180X Satellite



 Δ VNET silica 15







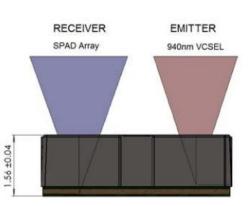
△VNET silica 1





VL53L1 new generation ToF ranging sensor





Advanced multi-zone and multi-object detection

· Fully integrated miniature module

 Emitter: 940nm invisible laser (VCSEL) and its analog driver

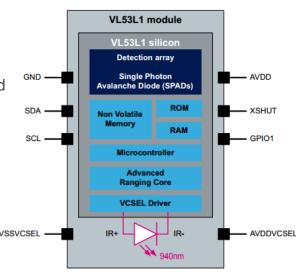
Receiving array with integrated lens

 Low-power micro-controller running advanced digital firmware

Size: 4.9 x 2.5 x 1.56mm

Fast, accurate distance ranging

- 400cm+ detection with full FoV
- 60Hz ranging capable up to 300cm
- Immune to coverglass cross-talk and fingerprint smudge at long distance with patented algorithms (direct ToF)
- Multi-object detection capable
- Multi-zone scanning with selectable array (2x2, 3x3, 4x4, or defined by user through software)





MEMS microphones

MEMS vs. ECM microphones

		MEMS Microphones			ECM: Electret Condenser Microphones
Soldering	order order	Easy Reflow		Temperature stability issue: requires additional controls	
Form Factor	puluuluuli	Convenient for ultra thin or multiple Mics designs		Usually bigger	
Vibrations Robustness		More robust		requires rubber gaske	
Temperature		Immune to variation		Impacted	
Electromagnetic Interferences	WWW	Immune (package is a Faraday cage)		More	e impacted
Part-to-part Sensitivity Matchi	ng A	Excellent (+/- (standard dev		D	ifficult

12/2017



Bluecoin – the Robotic Ear

STEVAL-BCNKT01V1



12/2017



Bluecoin – the Robotic Ear

capabilities

osxAcousticSL

Sound Source Localization

Estimates the angle of arrival of audio signal using a MEMS microphone array

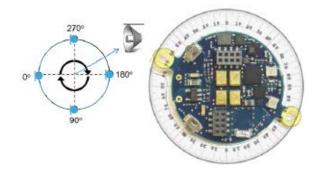
osxAcousticBF Beamforming

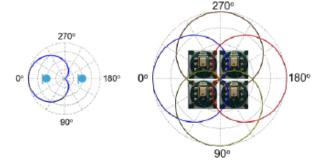
Small and compact directional virtual microphone based on ST MEMS microphone array

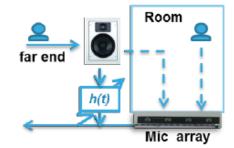
osxAcousticEC

Acoustic Echo Cancellation

Based on the *Speex.org* Open Source libraries







μ4(micro-4) architecture :The smallest microphone array architecture ever!

Microphone's sound inlets are just 3mm away from each other



Bluecoin – the Robotic Ear

DEMO set up



BlueCoin starter kit p/n STEVAL-BCNKT01V1



SMARTMIC1 GUI Included in the SMARTMIC1 library package





FREE AUDIO RECORDER Like i.e. Audacity

